

FDD16AN08_F085-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODU	CT SUMMARY		
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A) ^a	Q _g (Typ.)
100	0.0185 at V _{GS} = 10 V	45	38 nC

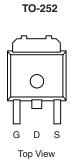
FEATURES

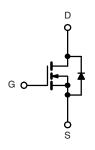
- Trench Power MOSFET
- 100 % R_g and UIS Tested





- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		45 ^a		
	T _C = 100 °C		30		
	T _A = 25 °C	I _D	9.2 ^b		
	T _A = 100 °C		6.8 ^b		
Pulsed Drain Current		I _{DM}	140	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		45 ^a		
	T _A = 25 °C	I _S	2 ^b		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	35		
Avalanche Energy	L = U.T IIII	E _{AS}	101	mJ	
Maximum Power Dissipation	T _C = 25 °C		136.4		
	T _C = 100 °C	В	68.2	w	
	T _A = 25 °C	P _D	3 _p	vv	
	T _A = 100 °C		1.5 ^b		
Operating Junction and Storage Temperature Ra	T _J , T _{stq}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State -	R _{thJA}	40	50	°C/W
Maximum Junction-to-Case		R _{thJC}	0.85	1.1	C/VV

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.



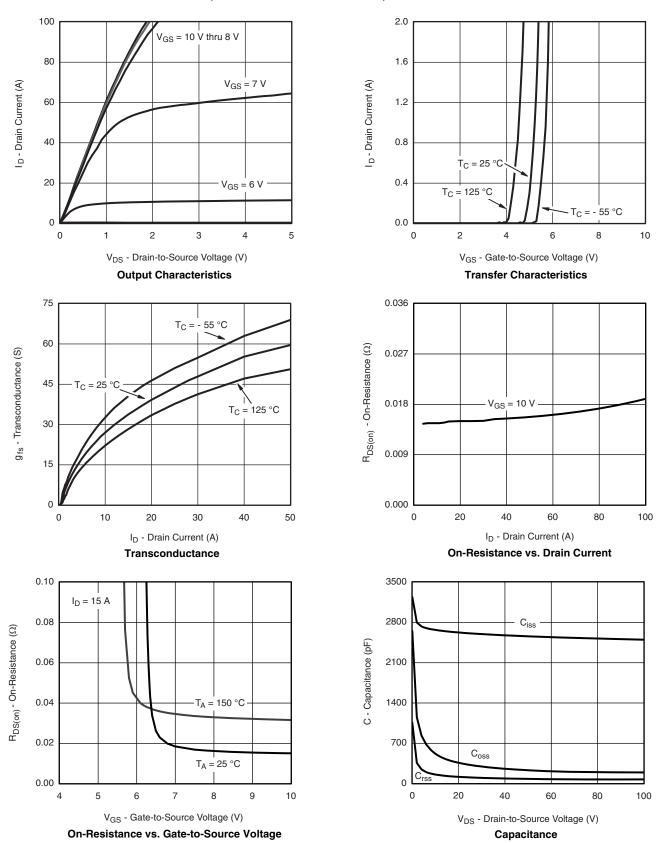
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$				V
$_{ m S}$ Temperature Coefficient $\Delta V_{ m DS}/T_{ m J}$		J 050 A		110		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l _D = 250 μA		- 12.5		IIIV/ C
Gate-Source Threshold Voltage	- ()		2.5		5	V
Gate-Source Leakage I _{GSS}		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Vara Cata Valtaga Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	0 V 1		1	
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance ^a R _{DS(}		$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$		0.0185		Ω
Forward Transconductance ^a		V _{DS} = 15 V, I _D = 15 A		33		S
Dynamic ^b						
Input Capacitance	C _{iss}			2400		
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		230		pF
Reverse Transfer Capacitance	C _{rss}			80		
Total Gate Charge	Q_g			38	70	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		14		
Gate-Drain Charge	Q _{gd}			12		
Gate Resistance		f = 1 MHz		1.6	2.5	Ω
Turn-On Delay Time	t _{d(on)}			12	20	- ns
Rise Time	t _r	V_{DD} = 50 V, R_L = 1 Ω		10	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		18	35	
Fall Time	t _f			8	15	
Drain-Source Body Diode Characteris	stics					
Continuous Source-Drain Diode	I _S	T _C = 25 °C			35	_
Pulse Diode Forward Current ^a	I _{SM}	_			100	A
Body Diode Voltage	V_{SD}	I _S = 15 A		0.85	1.5	V
Body Diode Reverse Recovery Time	t _{rr}			80	120	ns
Body Diode Reverse Recovery Charge	Q _{rr}			160	240	nC
Reverse Recovery Fall Time	t _a	$I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		57		ns
Reverse Recovery Rise Time	t _b			23		

Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

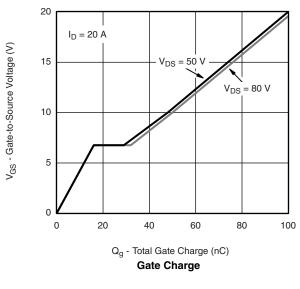
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

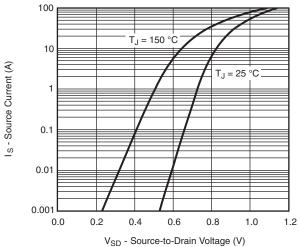


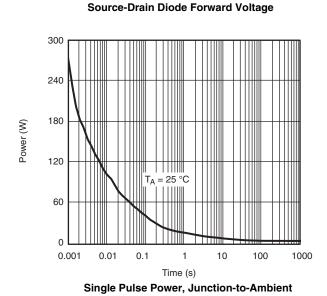


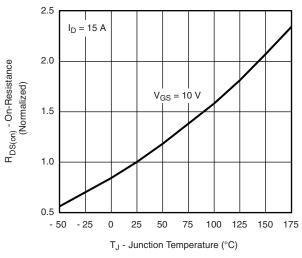
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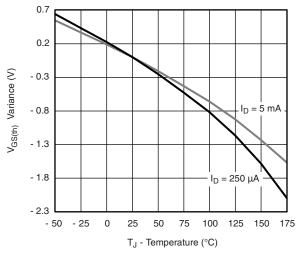




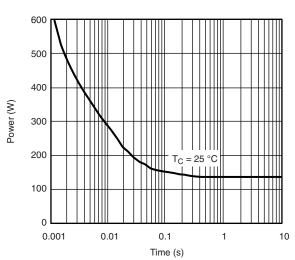






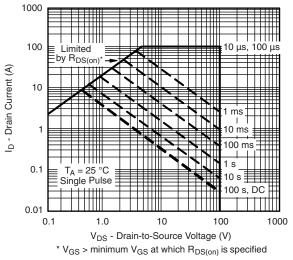




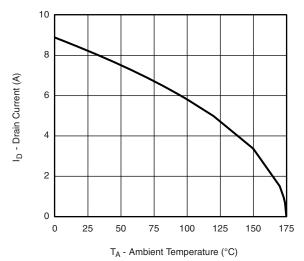


Single Pulse Power, Junction-to-Case

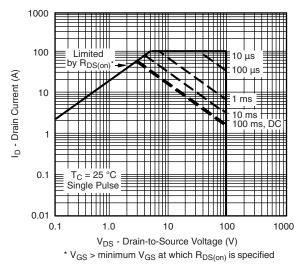


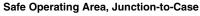


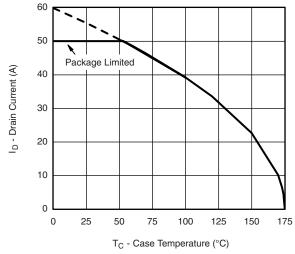




Current Derating**, Junction-to-Ambient



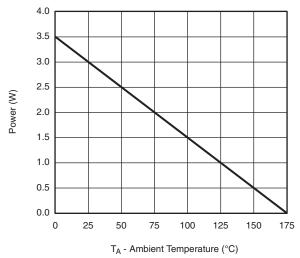


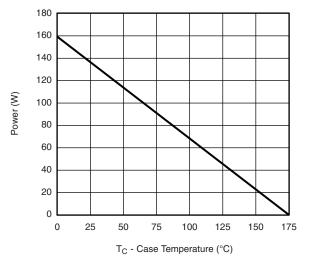


Current Derating**, Junction-to-Case

^{**} The power dissipation P_D is based on $T_{J(max.)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





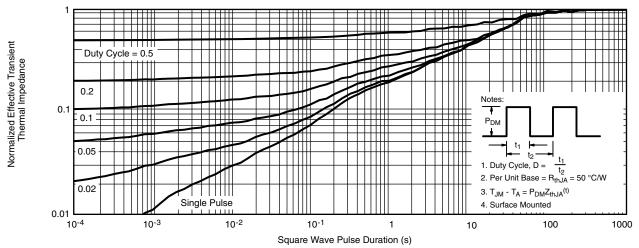


Power Derating**, Junction-to-Ambient

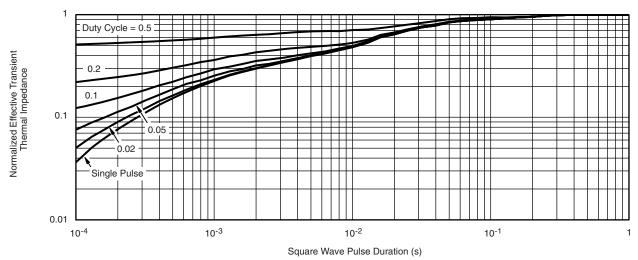
Power Derating**, Junction-to-Case

^{**} The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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